

# Silicon carbide Power MOSFET 1200 V, 45 A, 90 mΩ (typ., T<sub>J</sub> = 150 °C) in an HiP247<sup>™</sup> package

Datasheet - production data

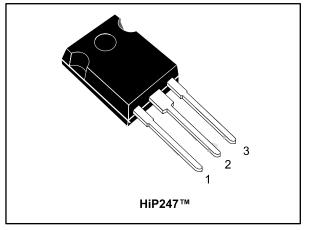
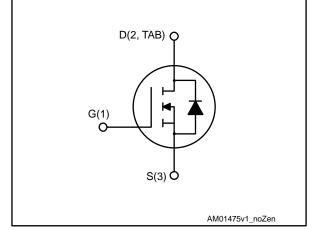


Figure 1: Internal schematic diagram



#### Features

- Very tight variation of on-resistance vs. temperature
- Very high operating junction temperature capability (T<sub>J</sub> = 200 °C)
- Very fast and robust intrinsic body diode
- Low capacitance

### **Applications**

- Solar inverters, UPS
- Motor drives
- High voltage DC-DC converters
- Switch mode power supply

### Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance almost independent of temperature. The outstanding thermal properties of the SiC material, combined with the device's housing in the proprietary HiP247<sup>™</sup> package, allows designers to use an industry standard outline with significantly improved thermal capability. These features render the device perfectly suitable for highefficiency and high power density applications.

#### Table 1: Device summary

Order code	der code Marking Package		Packaging	
SCT30N120	SCT30N120	HiP247™	Tube	

This is information on a product in full production.

#### Contents

### Contents

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### 1 Electrical ratings

 Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
Vds	Drain-source voltage	1200	V
V <sub>GS</sub>	Gate-source voltage	-10 to 25	V
ID	Drain current (continuous) at $T_c = 25 \ ^\circ C$ (limited by die)	45	А
ID	Drain current (continuous) at $T_c = 25 \ ^{\circ}C$ (limited by package)	40	А
ID	Drain current (continuous) at T <sub>c</sub> = 100 °C	34	А
IDM <sup>(1)</sup>	Drain current (pulsed)	90	А
Ртот	Total dissipation at $T_C = 25 \ ^{\circ}C$	270	W
T <sub>stg</sub>	Storage temperature range	EE to 200	°C
Tj	Operating junction temperature range	-55 to 200	°C

#### Notes:

<sup>(1)</sup>Pulse width limited by safe operating area.

#### Table 3: Thermal data

Symbol	Parameter	Value	Unit
Rthj-case	Thermal resistance junction-case	0.65	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	40	°C/W



### 2 Electrical characteristics

(T<sub>CASE</sub> = 25 °C unless otherwise specified).

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Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
		$V_{DS}$ = 1200 V; $V_{GS}$ = 0 V		1	25	μA
I <sub>DSS</sub> Zero gate voltage drain current			50		μA	
Igss	Gate-body leakage current	$V_{DS} = 0 V;$ $V_{GS} = -10 \text{ to } 22 V$			±100	nA
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 1 \text{ mA}$	1.8	3.5		V
		$V_{GS} = 20 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		80	100	mΩ
R <sub>DS(on)</sub>	Static drain-source on- resistance	$V_{GS} = 20 \text{ V}, I_D = 20 \text{ A},$ $T_J = 150 ^{\circ}\text{C}$		90		mΩ
		V <sub>GS</sub> = 20 V, I <sub>D</sub> = 20 A, T <sub>J</sub> = 200 °C		100		mΩ

#### Table 4: On/off states

Table 5: Dynamic

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Ciss	Input capacitance		-	1700	-	pF
Coss	Output capacitance	V <sub>DS</sub> = 400 V, f = 1 MHz, V <sub>GS</sub> = 0 V	-	130	-	pF
Crss	Reverse transfer capacitance	VGS - 0 V	-	25	-	pF
Qg	Total gate charge		-	105	-	nC
Q <sub>gs</sub>	Gate-source charge	$V_{DD} = 800 \text{ V}, I_D = 20 \text{ A},$ $V_{GS} = 0 \text{ to } 20 \text{ V}$	-	16	-	nC
$Q_{gd}$	Gate-drain charge	VGS = 0 10 20 V	-	40	-	nC
Rg	Gate input resistance	f=1 MHz open drain	-	5	-	Ω

#### Table 6: Switching energy (inductive load)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
Eon	Turn-on switching energy	V <sub>DD</sub> = 800 V, I <sub>D</sub> = 20 A,	-	500	-	μJ
Eoff	Turn-off switching energy	$R_G$ = 6.8 $\Omega$ , $V_{GS}$ = -2 to 20 V	-	350	-	μJ
Eon	Turn-on switching energy	V <sub>DD</sub> = 800 V, I <sub>D</sub> = 20 A,	-	500	-	μJ
E <sub>off</sub>	Turn-off switching energy	R <sub>G</sub> = 6.8 Ω, V <sub>GS</sub> = -2 to 20 V T <sub>J</sub> = 150 °C	-	400	-	μJ

Table 7: Switching times

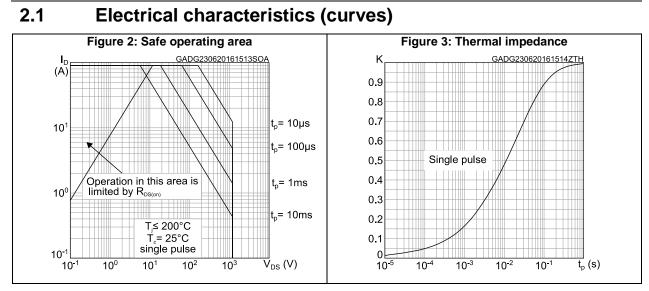
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
t <sub>d(on)</sub>	Turn-on delay time		-	19	-	ns
t <sub>f</sub>	Fall time	$V_{DD} = 800 \text{ V}, I_D = 20 \text{ A},$ $R_G = 0 \Omega, V_{GS} = 0 \text{ to } 20 \text{ V}$	-	28	-	ns
t <sub>d(off)</sub>	Turn-off delay time		-	45	-	ns
tr	Rise time		-	20	-	ns

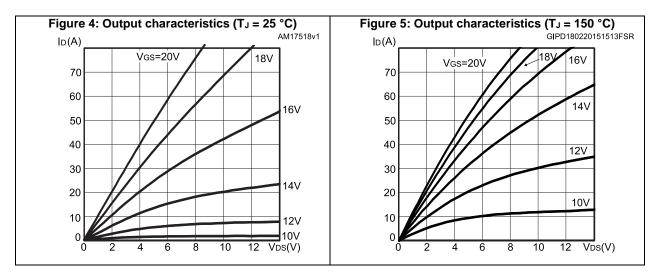


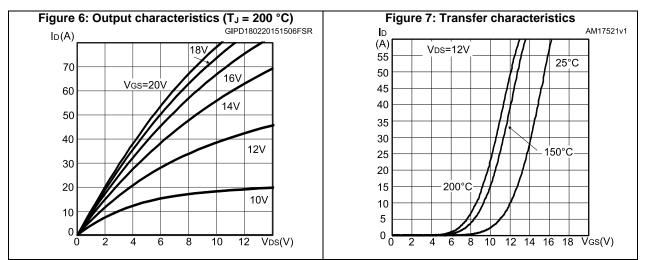
Symbol	Parameter	Test conditions	Min	Тур.	Max	Unit
Vsd	Diode forward voltage	$I_F = 10 \text{ A}, V_{GS} = 0 \text{ V}$	-	3.5	-	V
trr	Reverse recovery time		-	140		ns
Qrr	Reverse recovery charge	I <sub>SD</sub> = 20 A, di/dt = 100 A/µs V <sub>DD</sub> = 800 V	-	140	-	nC
I <sub>RRM</sub>	Reverse recovery current		-	2	-	А

Table 8:	Reverse	SiC diode	e characteristics
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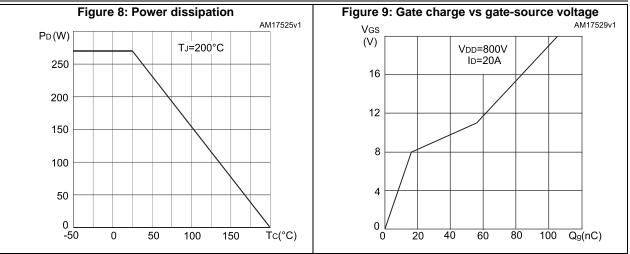


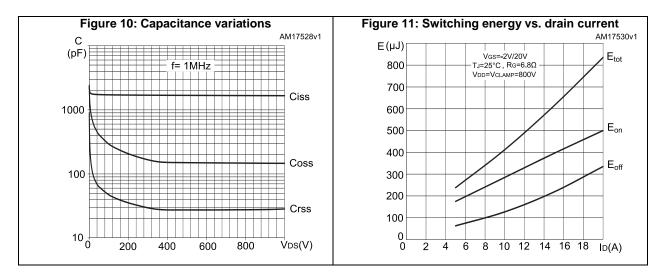
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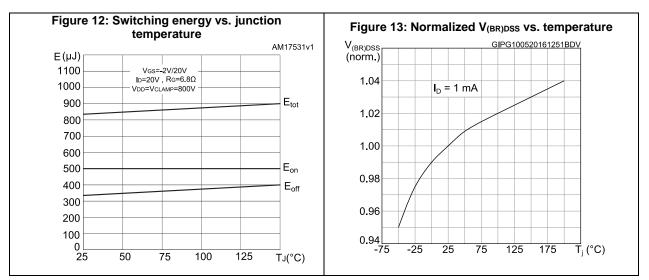


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#### **Electrical characteristics**



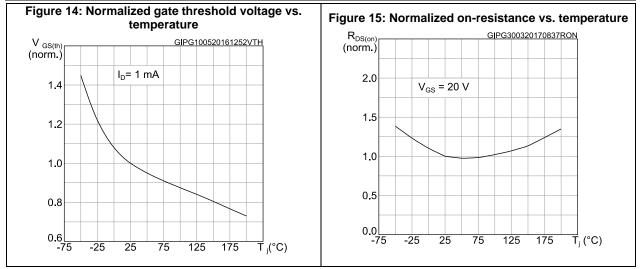


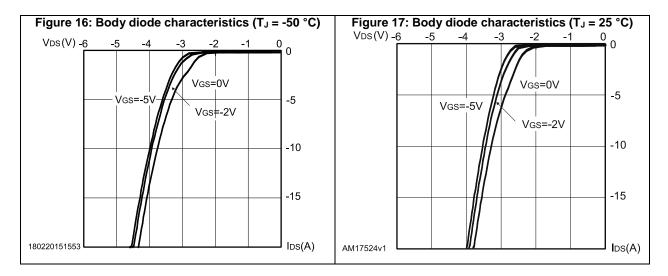


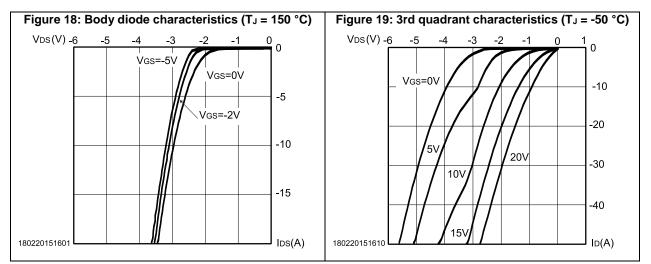
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#### **Electrical characteristics**

#### SCT30N120





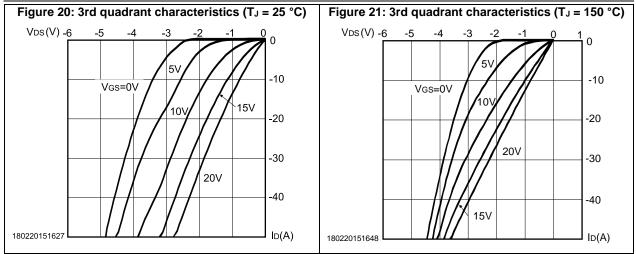


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#### **Electrical characteristics**





### 3 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK<sup>®</sup> is an ST trademark.

### 3.1 HiP247 package information

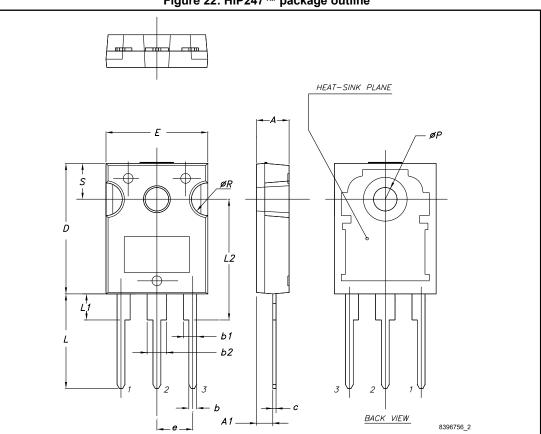


Figure 22: HiP247™ package outline



#### Package information

20	Package Informa				
	Table 9: HiP247™ pa	ckage mechanical data			
Dim		mm			
Dim.	Min.	Тур.	Max.		
А	4.85		5.15		
A1	2.20		2.60		
b	1.0		1.40		
b1	2.0		2.40		
b2	3.0		3.40		
С	0.40		0.80		
D	19.85		20.15		
E	15.45		15.75		
е	5.30	5.45	5.60		
L	14.20		14.80		
L1	3.70		4.30		
L2		18.50			
ØP	3.55		3.65		
ØR	4.50		5.50		
S	5.30	5.50	5.70		



### 4 Revision history

Table 10: Document revision history

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Date	Revision	Changes
10-May-2012	1	First release
21-May-2013	2	Updated trr value in Table8. Updated dynamic parameters in Table5, VGS(th) in Table4 and Eon in Table6.
24-Jun-2013	3	Document status promoted from target to preliminary data. Added: Section2.1: Electrical characteristics (curves)
11-Jul-2013	4	Updated Figure6: Output characteristics (TJ=200°C) and Figure7: Transfer characteristics.
18-Dec-2013	5	Updated parameters in Table2: Absolute maximum ratings and Table4: On/off states.
27-May-2014	6	Added Table7: Switching times. Updated Section3: Package mechanical data. Minor text changes.
25-Sep-2014	7	Document status promoted from preliminary to production data.
17-Feb-2015	8	Updated title in cover page.
20-Feb-2015	9	Updated Section2.1: Electrical characteristics (curves).
24-Jul-2016	10	Updated title and features in cover page. Updated <i>Figure 2: "Safe operating area" and Figure 3: "Thermal impedance".</i> Minor text changes.
11-May-2017	11	Updated Table 4: "On/off states" and Section 2.1: "Electrical characteristics (curves)". Minor text changes.



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